



# FDMS86263P

## P-Channel PowerTrench<sup>®</sup> MOSFET

-150 V, -22 A, 53 mΩ

### Features

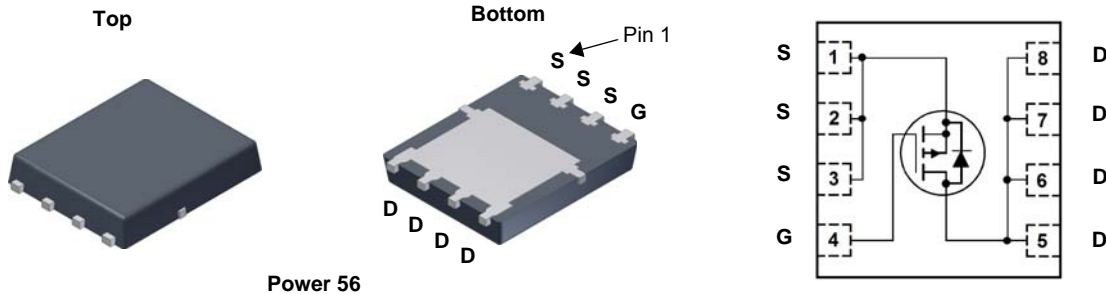
- Max  $r_{DS(on)}$  = 53 mΩ at  $V_{GS} = -10$  V,  $I_D = -4.4$  A
- Max  $r_{DS(on)}$  = 64 mΩ at  $V_{GS} = -6$  V,  $I_D = -4$  A
- Very low  $R_{ds-on}$  in Mid-Voltage P-Channel silicon technology optimized for low  $Q_g$
- This product is optimised for fast switching applications as well as load switch applications
- 100% UIL tested
- RoHS Compliant

### General Description

This P-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> technology. This very high density process is especially tailored to minimize on-state resistance and optimized for superior switching performance.

### Applications

- Active Clamp Switch
- Load Switch



Power 56

### MOSFET Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rated	Units
$V_{DS}$	Drain to Source Voltage	-150	V
$V_{GS}$	Gate to Source Voltage	$\pm 25$	V
$I_D$	Drain Current -Continuous	$T_C = 25^\circ\text{C}$	-22
	-Continuous	$T_A = 25^\circ\text{C}$ (Note 1a)	-4.4
	-Pulsed		-70
$E_{AS}$	Single Pulse Avalanche Energy	(Note 3)	384
$P_D$	Power Dissipation	$T_C = 25^\circ\text{C}$	104
	Power Dissipation	$T_A = 25^\circ\text{C}$ (Note 1a)	2.5
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ\text{C}$

### Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.2	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86263P	FDMS86263P	Power 56	13 "	12 mm	3000 units

FDMS86263P P-Channel PowerTrench<sup>®</sup> MOSFET

## Electrical Characteristics $T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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### Off Characteristics

$BV_{DSS}$	Drain to Source Breakdown Voltage	$I_D = -250\text{ }\mu\text{A}$ , $V_{GS} = 0\text{ V}$	-150			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250\text{ }\mu\text{A}$ , referenced to $25\text{ }^\circ\text{C}$		-116		mV/ $^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = -120\text{ V}$ , $V_{GS} = 0\text{ V}$			-1	$\mu\text{A}$
$I_{GSS}$	Gate to Source Leakage Current	$V_{GS} = \pm 25\text{ V}$ , $V_{DS} = 0\text{ V}$			$\pm 100$	nA

### On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = -250\text{ }\mu\text{A}$	-2	-2.9	-4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250\text{ }\mu\text{A}$ , referenced to $25\text{ }^\circ\text{C}$		7		mV/ $^\circ\text{C}$
$r_{DS(on)}$	Static Drain to Source On Resistance	$V_{GS} = -10\text{ V}$ , $I_D = -4.4\text{ A}$		42	53	m $\Omega$
		$V_{GS} = -6\text{ V}$ , $I_D = -4\text{ A}$		45	64	
		$V_{GS} = -10\text{ V}$ , $I_D = -4.4\text{ A}$ , $T_J = 125\text{ }^\circ\text{C}$		71	94	
$g_{FS}$	Forward Transconductance	$V_{DS} = -10\text{ V}$ , $I_D = -4.4\text{ A}$		19		S

### Dynamic Characteristics

$C_{iss}$	Input Capacitance	$V_{DS} = -75\text{ V}$ , $V_{GS} = 0\text{ V}$ , $f = 1\text{ MHz}$		2935	3905	pF
$C_{oss}$	Output Capacitance			238	315	pF
$C_{rss}$	Reverse Transfer Capacitance			11	20	pF
$R_g$	Gate Resistance		0.1	2.7	5.4	$\Omega$

### Switching Characteristics

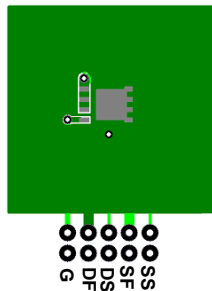
$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = -75\text{ V}$ , $I_D = -4.4\text{ A}$ , $V_{GS} = -10\text{ V}$ , $R_{GEN} = 6\text{ }\Omega$		17	31	ns
$t_r$	Rise Time			10	21	ns
$t_{d(off)}$	Turn-Off Delay Time			37	59	ns
$t_f$	Fall Time			14	25	ns
$Q_g$	Total Gate Charge	$V_{GS} = 0\text{ V to } -10\text{ V}$	$V_{DD} = -75\text{ V}$ , $I_D = -4.4\text{ A}$	45	63	nC
$Q_g$	Total Gate Charge	$V_{GS} = 0\text{ V to } -6\text{ V}$		29	40	nC
$Q_{gs}$	Gate to Source Charge			11.3		nC
$Q_{gd}$	Gate to Drain "Miller" Charge			8.9		nC

### Drain-Source Diode Characteristics

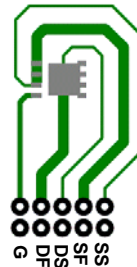
$V_{SD}$	Source to Drain Diode Forward Voltage	$V_{GS} = 0\text{ V}$ , $I_S = -4.4\text{ A}$ (Note 2)		-0.79	-1.3	V
		$V_{GS} = 0\text{ V}$ , $I_S = -2\text{ A}$ (Note 2)		-0.75	-1.2	
$t_{rr}$	Reverse Recovery Time	$I_F = -4.4\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$		91	146	ns
$Q_{rr}$	Reverse Recovery Charge			287	460	nC

#### Notes:

1.  $R_{\theta JA}$  is determined with the device mounted on a  $1\text{ in}^2$  pad 2 oz copper pad on a  $1.5 \times 1.5\text{ in.}$  board of FR-4 material.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.



a)  $50\text{ }^\circ\text{C/W}$  when mounted on a  $1\text{ in}^2$  pad of 2 oz copper

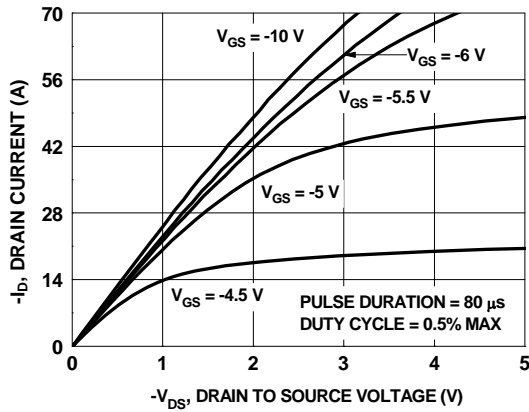


b)  $125\text{ }^\circ\text{C/W}$  when mounted on a minimum pad of 2 oz copper.

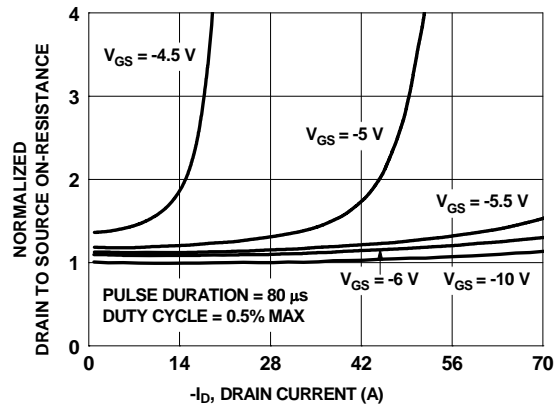
2. Pulse Test: Pulse Width  $< 300\text{ }\mu\text{s}$ , Duty cycle  $< 2.0\%$ .

3. Starting  $T_J = 25\text{ }^\circ\text{C}$ ; P-ch:  $L = 3\text{ mH}$ ,  $I_{AS} = -16\text{ A}$ ,  $V_{DD} = -150\text{ V}$ ,  $V_{GS} = -10\text{ V}$ . 100% test at  $L = 0.1\text{ mH}$ ,  $I_{AS} = -52\text{ A}$ .

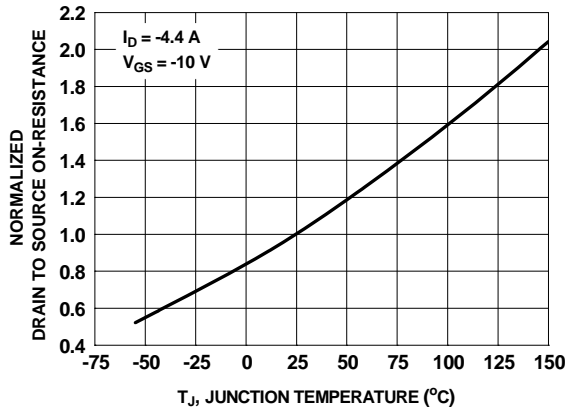
**Typical Characteristics**  $T_J = 25\text{ }^\circ\text{C}$  unless otherwise noted



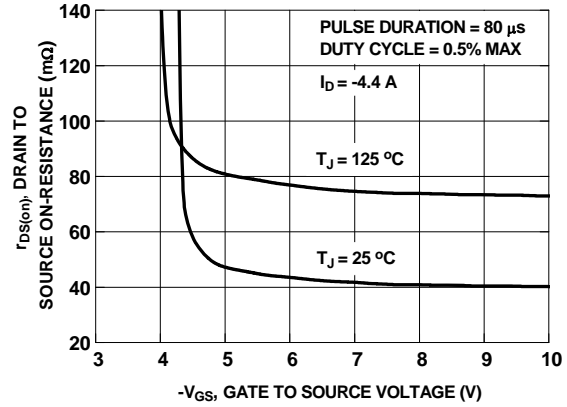
**Figure 1. On Region Characteristics**



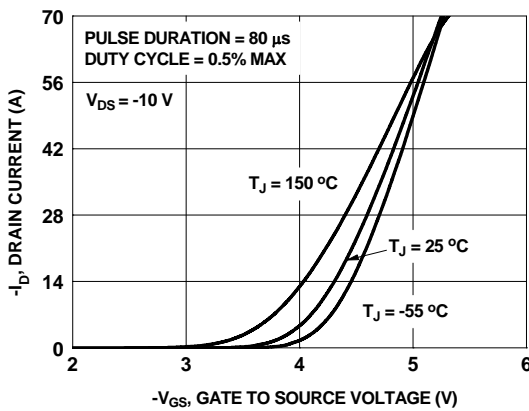
**Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage**



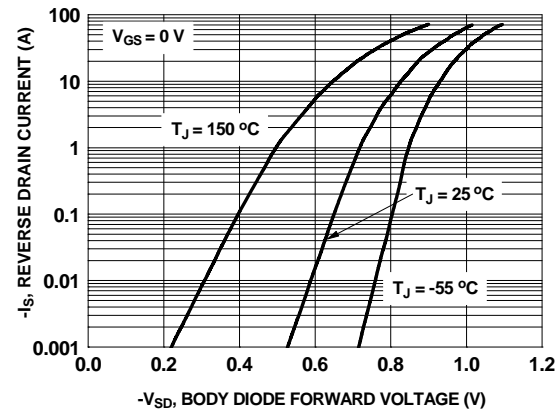
**Figure 3. Normalized On Resistance vs Junction Temperature**



**Figure 4. On-Resistance vs Gate to Source Voltage**

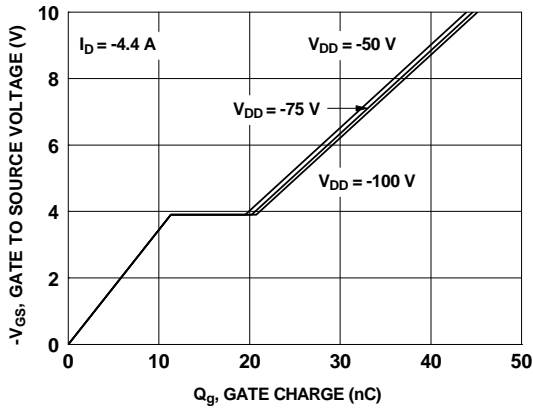


**Figure 5. Transfer Characteristics**

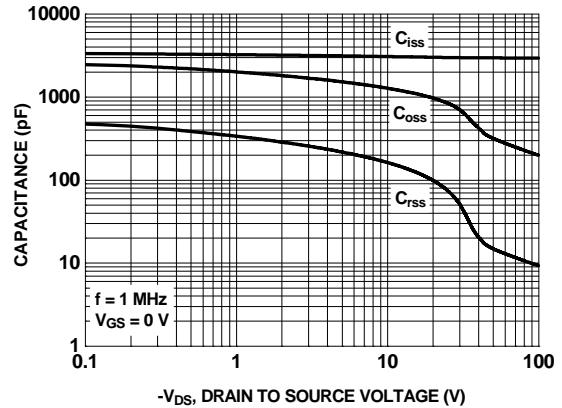


**Figure 6. Source to Drain Diode Forward Voltage vs Source Current**

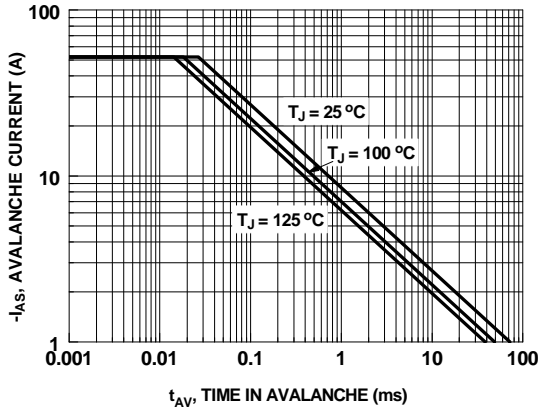
**Typical Characteristics**  $T_J = 25^\circ\text{C}$  unless otherwise noted



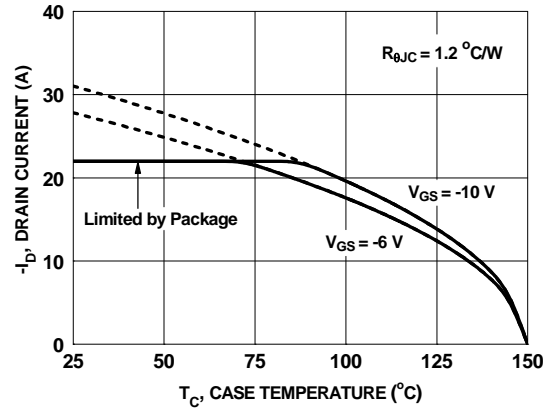
**Figure 7. Gate Charge Characteristics**



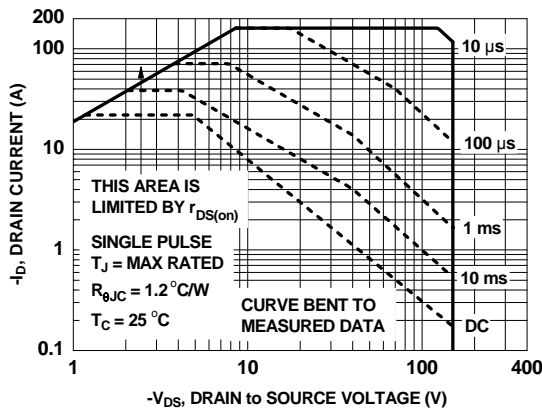
**Figure 8. Capacitance vs Drain to Source Voltage**



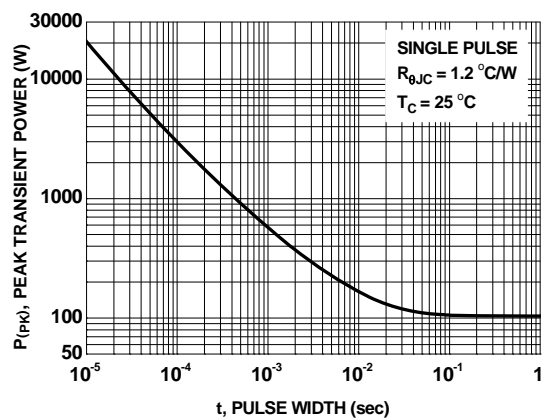
**Figure 9. Unclamped Inductive Switching Capability**



**Figure 10. Maximum Continuous Drain Current vs Case Temperature**

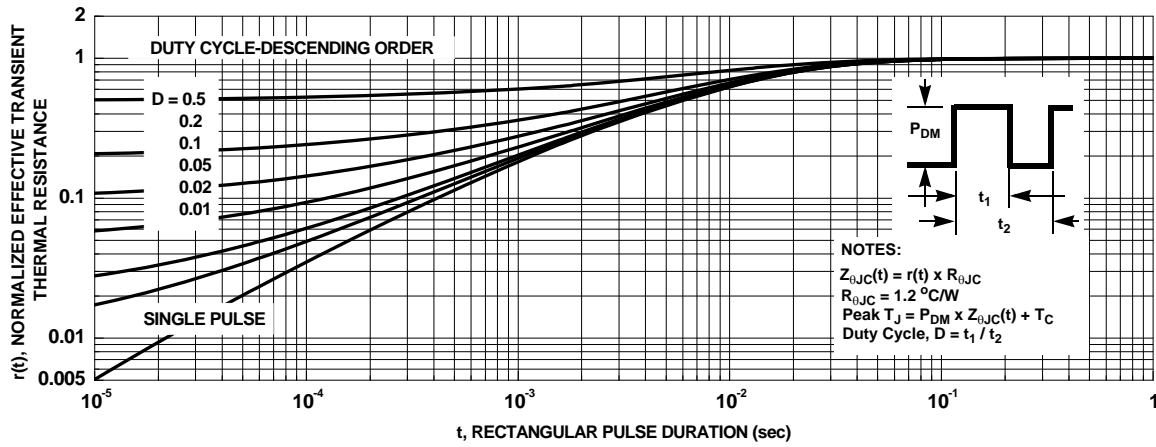


**Figure 11. Forward Bias Safe Operating Area**



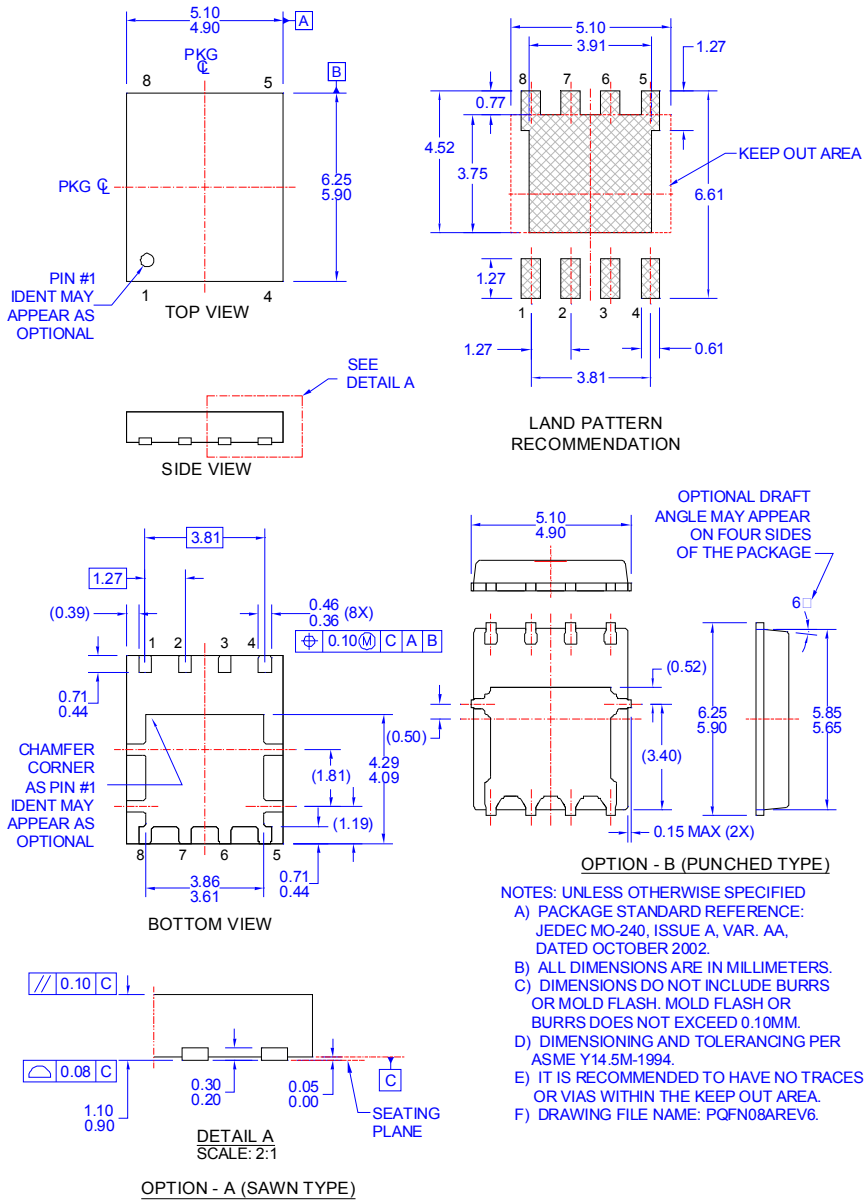
**Figure 12. Single Pulse Maximum Power Dissipation**

**Typical Characteristics**  $T_J = 25\text{ }^\circ\text{C}$  unless otherwise noted



**Figure 13. Junction-to-Case Transient Thermal Response Curve**

## Dimensional Outline and Pad Layout




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